V12PM12

Vishay General Semiconductor

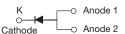
High Current Density Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.53$ V at $I_F = 6$ A

eSMP[®] Series

www.vishay.com

SMPC (TO-277A)



click logo to get started

DESIGN SUPPORT TOOLS



PRIMARY CHARACTERISTICS				
I _{F(AV)}	12 A			
V _{RRM}	120 V			
I _{FSM}	160 A			
V_F at $I_F = 12$ A	0.63 V			
T _J max.	175 °C			
Package	SMPC (TO-277A)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 1.1 mm
- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- · High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 gualified available - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling, and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 gualified

("_X") denotes revision code e.g. A, B,)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V12PM12	UNIT	
Device marking code		12M12		
Maximum repetitive peak reverse voltage	V _{RRM}	120	V	
Maximum DC forward current	Ι _Ε ⁽¹⁾	12	A	
Maximum DC forward current	I _F ⁽²⁾	4.1		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	_{SM} 160		
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C	
Storage temperature range	T _{STG}	-55 to +175	°C	

Notes

⁽¹⁾ Mounted on 30 mm x 30 mm pad areas aluminum PCB

⁽²⁾ Free air, mounted on recommended pad area

⁽³⁾ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta,JA}$

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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 6 A	T _A = 25 °C	V _F ⁽¹⁾	0.60	-	V
	I _F = 12 A			0.75	0.83	
	I _F = 6 A	- T _A = 125 °C		0.53	-	
	I _F = 12 A			0.63	0.71	
Reverse current	V _B = 90 V	T _A = 25 °C	I _R (2)	3	-	μA
	v _R = 90 v	T _A = 125 °C		2	-	mA
	V _R = 120 V	T _A = 25 °C		-	500	μA
		T _A = 125 °C		5	35	mA
Typical junction capacitance	4.0 V, 1 MHz		CJ	950	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 5 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V12PM12	UNIT	
Typical thermal resistance	R _{0JA} ⁽¹⁾⁽²⁾	62	°C/W	
rypical memaresistance	R _{0JM} ⁽³⁾	4	0/10	

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

 $^{(2)}$ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

 $^{(3)}$ Units mounted on 30 mm x 30 mm aluminum PCB, thermal resistance $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
V12PM12-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel		
V12PM12-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel		
V12PM12HM3_A/H ⁽¹⁾	0.10	Н	1500	7" diameter plastic tape and reel		
V12PM12HM3_A/I ⁽¹⁾	0.10	I	6500	13" diameter plastic tape and reel		

Note

⁽¹⁾ Automotive grade



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

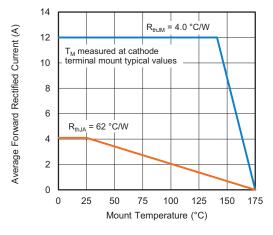


Fig. 1 - Forward Current Derating Curve

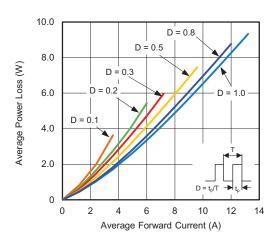


Fig. 2 - Forward Power Loss Characteristics

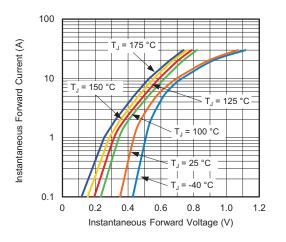


Fig. 3 - Typical Instantaneous Forward Characteristics

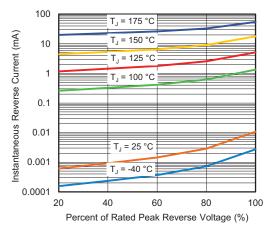


Fig. 4 - Typical Reverse Leakage Characteristics

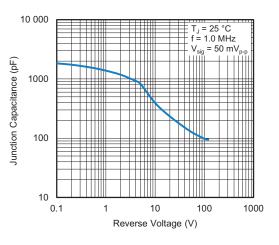


Fig. 5 - Typical Junction Capacitance

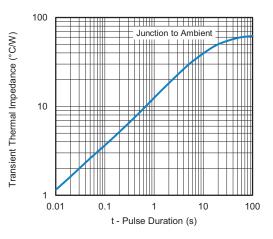


Fig. 6 - Typical Transient Thermal Impedance

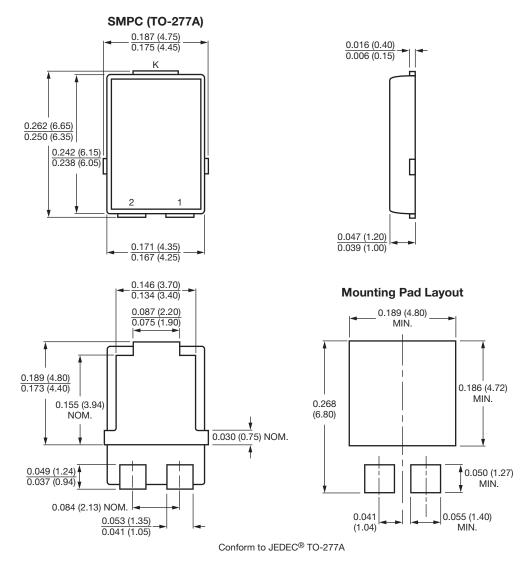
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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